



AMP-IN

TE Internal #: 60598-4

TE Internal Description: 058 PIN REC IS 22-20 010TPBECU

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Terminals & Splices > PCB Terminals



PCB Terminal Type: **Receptacle**

PCB Hole Diameter: **3.68 mm [ .145 in ]**

Mating Pin Diameter: **1.47 mm [ .058 in ]**

Compatible Insulation Diameter (Max): **1.78 mm [ .07 in ]**

Compatible Insulation Diameter Range: **1.14 – 1.78 mm [ .045 – .07 in ]**

**Features**

**Product Type Features**

Terminal Features	Stud Hole
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**Contact Features**

Contact Mating Area Plating Material Thickness	2.03 – 5.08 μm[80 – 200 μin]
PCB Terminal Type	Receptacle
Mating Pin Diameter	1.47 mm[.058 in]
Terminal Plating Material	Tin
Terminal Orientation	Straight

**Termination Features**

Termination Method to Printed Circuit Board	Through Hole - Solder
Product Terminates To	Wire & Cable

**Mechanical Attachment**

Wire Insulation Support	With
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**Dimensions**

Terminal Material Thickness	.25 mm[.01 in]
PCB Hole Diameter	3.68 mm[.145 in]

Compatible Insulation Diameter (Max)	1.78 mm[.07 in]
Compatible Insulation Diameter Range	1.14 – 1.78 mm[.045 – .07 in]
Wire Size	.2 – .6 mm <sup>2</sup>

### Usage Conditions

Insulation Option	Uninsulated
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

### Packaging Features

Packaging Quantity	15000
Packaging Method	Reel

### Product Compliance

For compliance documentation, visit the product page on [TE.com](https://www.te.com)>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

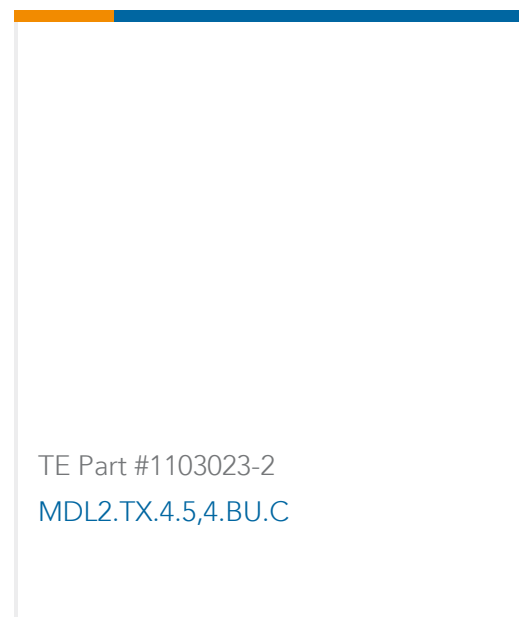
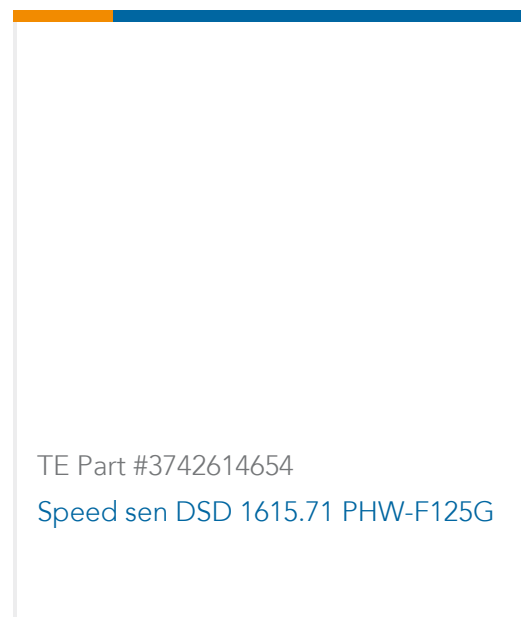
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



### Customers Also Bought



### Documents

[CAD Files](#)

[3D PDF](#)

English

Customer View Model

[ENG\\_CVM\\_60598-4\\_AH.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_60598-4\\_AH.3d\\_stp.zip](#)

English



**Customer View Model**

[ENG\\_CVM\\_60598-4\\_AH.2d\\_dxf.zip](#)

English

**3D PDF**

3D

**Customer View Model**

[ENG\\_CVM\\_CVM\\_60598-4\\_BA.2d\\_dxf.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_CVM\\_60598-4\\_BA.3d\\_igs.zip](#)

English

**Customer View Model**

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English

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**Datasheets & Catalog Pages**

**PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS**

English

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**Product Specifications**

**Application Specification**

English